

**REMARKS**

The Examiner is thanked for the thorough examination and search of the subject.

Applicants have amended the Specification to improve the Title, and to provide information on related patents and patent applications.

In regards to the Title, Applicants have amended the Title to "BONDING STRUCTURE WITH PILLAR AND CAP" to limit the focus to the claimed invention. Applicants respectfully request that this title be entered by amendment.

In regards to the related patents and patent applications, Applicant has provided information on related patents and patent applications relevant to the present application.

Applicants have amended the claims to renumber claims 106-162 due to the previously-added claims 104 and 105 being overlapped.

In response to the Restriction Requirement mailed on September 20, 2005 regarding the above-identified application, Applicants elect Species of I) copper and C) lead-free alloy. Pursuant to the elected species, claims 92-93, 96-97, 99-123, 125-129, 151-154, and 156-162 are elected for further examination on merits. Please withdraw claims 94-95, 98, 124, 130-150, and 155 with prejudice and disclaimer.

Some or all of elected claims are believed to be in condition for Allowance, and that is so requested.

Respectfully submitted,



Mou-Shiung Lin/CEO  
For and on behalf of MEGIC  
Corporation

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WINSTON Hsu

Reg. NO. 41526

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